

Brief Description

The ZSPM4121 battery management load switch can be used to protect a battery from excessive discharge. It actively monitors the battery voltage and disconnects the battery from the load if the battery drops below a set voltage threshold. When the input battery voltage reaches 500mV above the set voltage threshold, the load switch turns on and connects the battery to the load. The 500mV hysteresis between the Off Mode and the On Mode prevents intermittent operation.

The voltage threshold (V_{THRESH}) can be programmed at manufacturing to a customer-selected set point in the voltage range of 1.2V to 4.2V in 100mV increments to support a wide range of applications in consumer, medical, portable, and industrial applications.

This device has ultra-low quiescent current, which makes it ideal for battery-powered applications. Typical quiescent current is 100pA in the Off Mode and 70nA in the On Mode.

The ZSPM4121 includes a slew rate control P-channel load switch, over-current protection, and an open-drain power indicator pin (NPG). The slew-rate controlled turn-on characteristic prevents inrush current and voltage droop on the voltage. The over-current limit protects the device in case of an overload, short-circuit, or ground fault event.

Benefits

- Best-in-class ultra-low quiescent current in Off Mode: 100pA (typical)
- Ultra-low quiescent current in On Mode: 70nA (typical)
- Accurate on/off voltage threshold
- Low Rds(on): 175mΩ (typical) @ 5V

Features

- Threshold voltage options of 1.2V to 4.2V in 100mV steps (factory programmed)
- Wide input voltage range: 1.2V to 5.5V
- Supervisory over-current limit shutdown: (3A)
- Low drop-out disconnect from VCC to loads
- Controlled turn-on slew rate
- 500mV Off Mode to On Mode hysteresis

Related IDT Smart Power Products

ZSPM4141 Ultra-Low-Power Linear Regulator

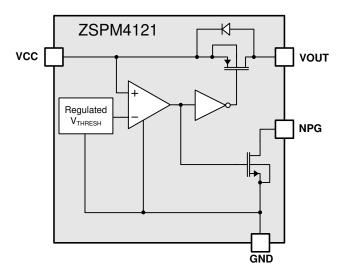
Available Support

- Evaluation Kit
- Support Documentation

Physical Characteristics

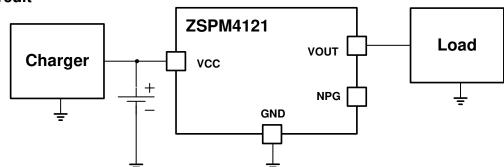
• Package: 8-pin DFN (2mm x 2mm)

ZSPM4121 Block Diagram





Typical Application Circuit



Typical Applications

- Portable batteries
- Industrial
- Medical
- Smart cards
- RFID

Ordering Information

Ordering Code*	Description	Package
ZSPM4121AI1 <i>W</i> 17	ZSPM4121 Under-Voltage Load Switch—V _{THRESH} factory set to 1.7V	8-pin DFN / 7" Reel (2500)
ZSPM4121Al1 <i>W</i> 21	ZSPM4121 Under-Voltage Load Switch—V _{THRESH} factory set to 2.1V	8-pin DFN / 7" Reel (2500)
ZSPM4121Al1 <i>W</i> 23	ZSPM4121 Under-Voltage Load Switch—V _{THRESH} factory set to 2.3V	8-pin DFN / 7" Reel (2500)
ZSPM4121AI1 <i>W</i> 24	ZSPM4121 Under-Voltage Load Switch—V _{THRESH} factory set to 2.4V	8-pin DFN / 7" Reel (2500)
ZSPM4121AI1 <i>W</i> 25	ZSPM4121 Under-Voltage Load Switch—V _{THRESH} factory set to 2.5V	8-pin DFN / 7" Reel (2500)
ZSPM4121AI1 <i>W</i> 26	ZSPM4121 Under-Voltage Load Switch—V _{THRESH} factory set to 2.6V	8-pin DFN / 7" Reel (2500)
ZSPM4121AI1 <i>W</i> 28	ZSPM4121 Under-Voltage Load Switch—V _{THRESH} factory set to 2.8V	8-pin DFN / 7" Reel (2500)
ZSPM4121AI1 <i>W</i> 30	ZSPM4121 Under-Voltage Load Switch—V _{THRESH} factory set to 3.0V	8-pin DFN / 7" Reel (2500)
ZSPM4121KIT	ZSPM4121 Evaluation Kit	

^{*} For a 13" reel (3300 parts), replace the W in the ordering code with an R. Custom V_{THRESH} values are also available: 1.2V to 4.2V (typical) in 100mV increments.



Contents

1 ZSPM	4121 Characteristics	5
1.1. Ab	solute Maximum Ratings	5
1.2. Th	ermal Characteristics	5
1.3. Re	commended Operating Conditions	5
1.4. Ele	ectrical Characteristics	6
2 Typica	Performance Characteristics	7
3 Descrip	otion of Circuit	8
4 Applica	ation Circuit	9
4.1. Ty	pical Application Circuit	9
5 Pin Co	nfiguration and Package	10
5.1. Pa	ckage Dimensions and Marking Diagram	10
5.2. Pir	n Description for 8-Pin DFN (2x2 mm)	11
6 Layout	and Soldering Requirements	12
6.1. Re	commended Landing Pattern for PCBs	12
6.2. Mu	ılti-Layer PCB Layout	13
6.3. Sir	ngle-Layer PCB Layout	14
7 Orderir	ng Information	15
8 Relate	d Documents	15
9 Glossa	ıry	16
10 Docum	ent Revision History	16
List of F	_	
Figure 2.1	On Mode / Off Mode Characteristics	
Figure 2.2	On Mode Switching Behavior	
Figure 2.3	On Mode / Off Mode Quiescent Current I _q	
Figure 2.4	Off Mode V _{THRESH} Temperature Performance	
Figure 2.5	On Mode / Off Mode Transition Delay	
Figure 2.6	Over-Current Retry Performance	
Figure 3.1	ZSPM4121 Block Diagram	
Figure 4.1	Application Circuit for Disconnecting the Load	
Figure 5.1	ZSPM4121 Package Drawing	
Figure 5.2	ZSPM4121 Pin Assignments (top view)	
Figure 6.1	Recommended Landing Pattern for 8-Pin DFN	
Figure 6.2	Package and PCB Land Configuration for Multi-Layer PCB	
Figure 6.3	JEDEC Standard FR4 Multi-Layer Board – Cross-Sectional View	
Figure 6.4	Conducting Heat Away from the Die using an Exposed Pad Package	
Figure 6.5	Application Using a Single-Layer PCB	14



List of Tables

Table 1.1	Absolute Maximum Ratings	. 5
	Thermal Characteristics for 8-Pin DFN (2mm x 2mm) Package	
	Recommended Operating Conditions	
Table 1.4	Electrical Characteristics	. 6
Table 5.1	Pin Description, 8-Pin DFN (2x2)	11



1 ZSPM4121 Characteristics

Stresses beyond those listed under "Absolute Maximum Ratings" (section 1.1) may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those recommended under "Recommended Operating Conditions" (section 1.3) is not implied. Exposure to absolute—maximum conditions for extended periods may affect device reliability.

1.1. Absolute Maximum Ratings

Over operating free—air temperature range unless otherwise noted. All voltage values are with respect to network ground terminal.

Table 1.1 Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Maximum voltage applied to the VCC, VOUT, and NPG pins		-0.3 to 6.0	V
Electrostatic Discharge – Human Body Model, according to the respective JESD22 JEDEC standard		2	kV
Electrostatic Discharge – Charged Device Model, according to the respective JESD22-C101 JEDEC standard		500	V
Operating Junction Temperature Range	T_J	-20 to 85	°C
Storage Temperature Range	T _{stg}	-65 to 150	°C
Lead Temperature (soldering, 10 seconds)		260	°C

1.2. Thermal Characteristics

Table 1.2 Thermal Characteristics for 8-Pin DFN (2mm x 2mm) Package

θ _{JA} (°C/W) ¹⁾		θ_{JC} (°C/W) ²⁾
73.1		10.7
This rating assumes a FR4 board only. This rating assumes a 1oz. copper JEDEC standard board with thermal vias. See section 6.1 for more information.		

1.3. Recommended Operating Conditions

Table 1.3 Recommended Operating Conditions

Parameter	Symbol	Min	Тур	Max	Unit
Unregulated Supply Input at VCC Pin	V_{CC}	1.2		5.5	V
Operating Ambient Temperature 1)	T _A	-20		55	°C
Operating Junction Temperature	TJ	-20		85	°C

5

Operating ambient temperature is only intended as a guideline. The operating junction temperature requirements must not be exceeded.



1.4. Electrical Characteristics

Electrical characteristics for V_{CC} = 1.2V to 5.5V (unless otherwise noted). Minimum and maximum characteristics are tested at T_J = 25°C.

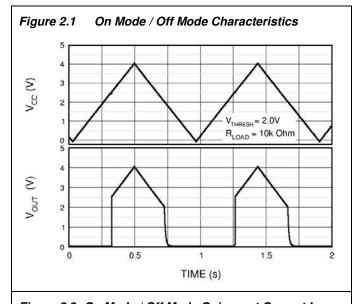
Table 1.4 Electrical Characteristics

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Input Supply						
Input Supply Voltage at VCC pin	Vcc		1.2		5.5	V
Quiescent Current: On Mode	I _{q-ON}	V _{CC} = 5V, no load		70	150	nA
Quiescent Current: Off Mode	I _{q-OFF}	V _{CC} < V _{THRESH} , no load		100		pА
Load Switch						
Over-Current Shutdown	loc	V _{CC} = 5.0V		3		Α
Over-Current Retry Period	toc	V _{CC} = 5.0V		1.7		ms
Output Switch Leakage Current	I _{LEAK-SW}	V _{CC} < V _{THRESH} ; V _{OUT} grounded		100		pА
Switch ON-Resistance	Rds-on	V _{CC} = 5.0V		175		mΩ
		V _{CC} = 3.3V		200		mΩ
		V _{CC} = 1.8V		350		mΩ
Transition Times			•			
Transition Delay: On Mode to Off Mode	t _{d1}	$V_{OFF} = 2.0V, V_{CC} = 3.0V \rightarrow 1.5V$		650		μS
Transition Delay: Off Mode to On Mode	t _{d2}	$V_{OFF} = 2.0V, V_{CC} = 1.5V \rightarrow 3.0V$		1.7		ms
Output Turn-on Rise Time	ton	$V_{CC} = 2.5V$, $R_{LOAD} = 50\Omega$		200		μs
NPG Output			•			
Output Leakage	I _{LEAK-NPG}	$V_{CC} = 5.0V, V_{NPG} = 5.5V$			100	nA
Low-Level Output Voltage	V _{OL-NPG}	I _{NPG} = 5 mA			0.4	V
Off Thresholds						
Off Threshold	V _{OFF}	V _{THRESH} = customer-selected threshold voltage in the range of 1.2V to 4.2V with 100mV steps between options programmed at manufacturing	0.95 * V _{THRESH}	V _{THRESH}	1.05 * V _{THRESH}	V
Off Mode to On Mode Hysteresis	V_{Hys}	Rising Transition: Off Mode to On Mode		500		mV



2 Typical Performance Characteristics

T = 25°C (unless otherwise noted)



Sigure 2.2 On Mode Switching Behavior

Closeup of Vour during slow Voc ramp

1.5

1.5

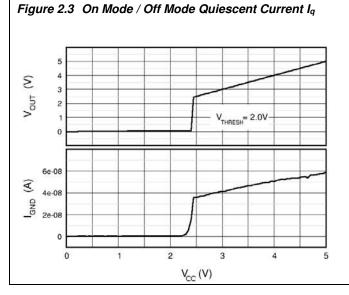
2

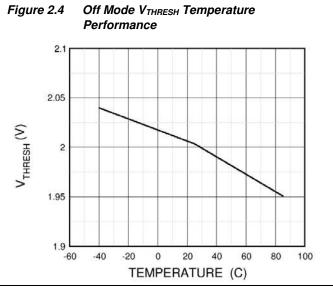
1.5

1

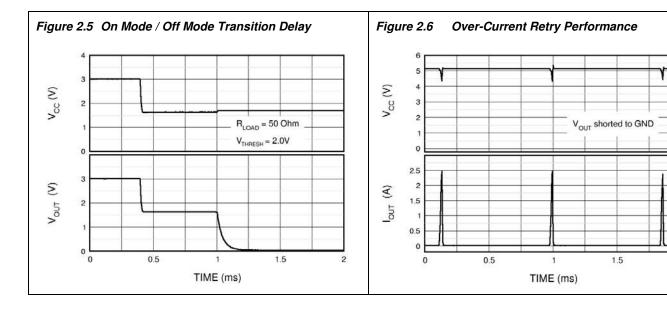
0.5

TIME (µs)





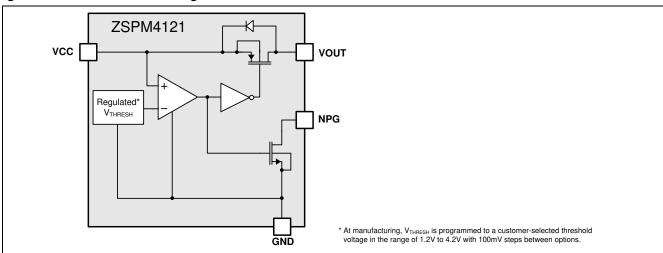




3 **Description of Circuit**

The ZSPM4121 battery management load switch includes an internally generated threshold voltage, comparator with hysteresis, slew rate control for the load switch, a P-channel load switch, and an open-drain indicator pin. When the input battery voltage rises to 500mV above the threshold, the load switch turns on (the On Mode). When the input battery voltage falls to the threshold voltage or below, the load switch is off (the Off Mode), and the quiescent current draw on the battery is in the order of 100pA (typical). The ZSPM4121 threshold voltage is programmed at manufacturing to an option in the range of 1.2V to 4.2V with 100mV steps between options. The 500mV hysteresis between the Off Mode and the On Mode prevents intermittent operation. The ZSPM4121 also provides over-current protection.

Figure 3.1 ZSPM4121 Block Diagram

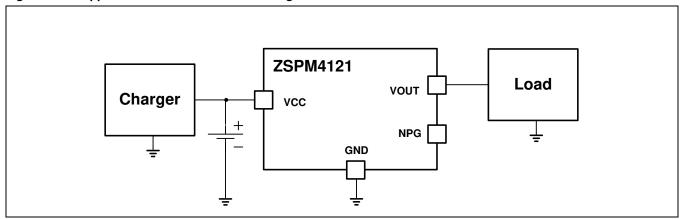




4 Application Circuit

4.1. Typical Application Circuit

Figure 4.1 Application Circuit for Disconnecting the Load

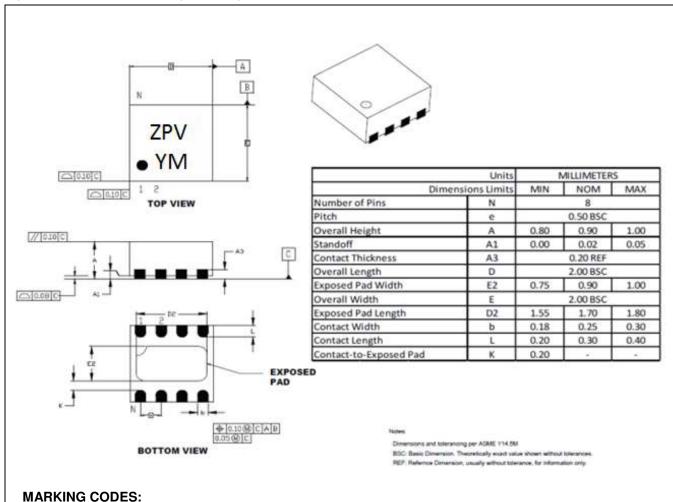




Pin Configuration and Package 5

5.1. **Package Dimensions and Marking Diagram**

Figure 5.1 ZSPM4121 Package Drawing



Z: ZMDI

P: Product Code: 0 = ZSPM4121

۷: Voltage levels: 0 = 1.2V, 1 = 1.3V, 2 = 1.4V, 3 = 1.5V, 4 = 1.6V, 5 = 1.7V, 6 = 1.8V, 7 = 1.9V, 8 = 2.0V,

9 = 2.1V, A = 2.2V, B = 2.3V, C = 2.4V, D to U = 2.5V to 4.2V

YM: Date Code (Year, Month)



5.2. Pin Description for 8-Pin DFN (2x2 mm)

Figure 5.2 ZSPM4121 Pin Assignments (top view)

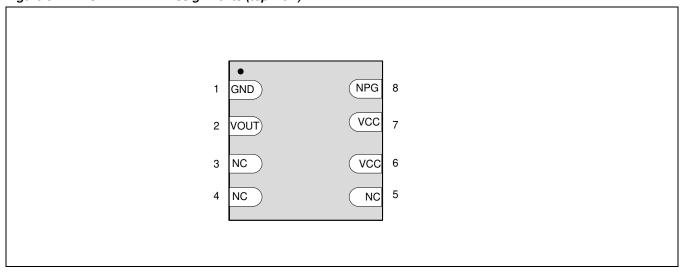


Table 5.1 Pin Description, 8-Pin DFN (2x2)

Pin#	Name	Function	Description
1	GND	Ground	GND
2	VOUT	Output	Output to system load
3	NC		No connection (connect to GND or float)
4	NC		No connection (connect to GND or float)
5	NC	No connection (connect to GND or float)	
6	VCC	Supply	Supply input (connect to pin 7 and VCC supply rail)
7	VCC	Supply	Supply input (connect to pin 6 and VCC supply rail)
8	NPG	Output	Open-drain N-channel output (low indicates "Power Good")

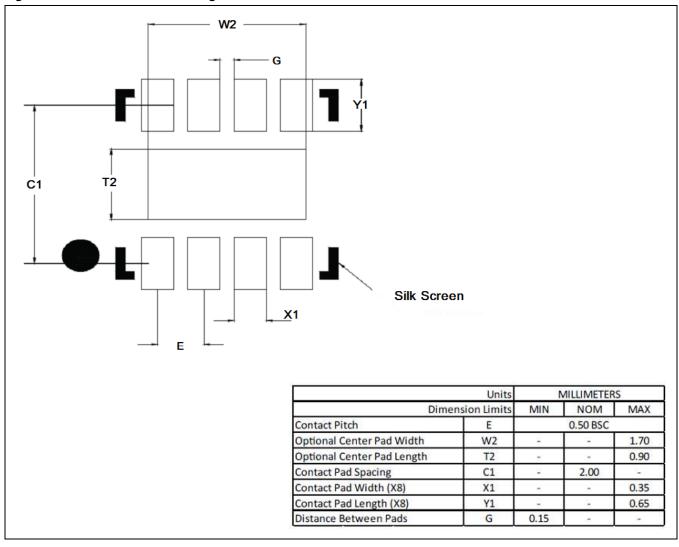


6 Layout and Soldering Requirements

To maximize the efficiency of this package for applications on a single layer or multi-layer printed circuit board (PCB), certain guidelines must be followed when laying out this part on the PCB.

6.1. Recommended Landing Pattern for PCBs

Figure 6.1 Recommended Landing Pattern for 8-Pin DFN





6.2. Multi-Layer PCB Layout

The following are guidelines for mounting the exposed pad ZSPM4121 on a multi-Layer PCB with ground a plane. In a multi-layer board application, the thermal vias are the primary method of heat transfer from the package thermal pad to the internal ground plane. The efficiency of this method depends on several factors, including die area, number of thermal vias, and thickness of copper, etc.

Figure 6.2 Package and PCB Land Configuration for Multi-Layer PCB

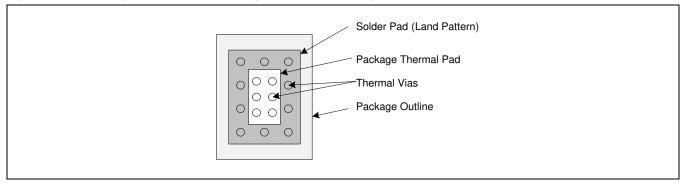


Figure 6.3 JEDEC Standard FR4 Multi-Layer Board – Cross-Sectional View

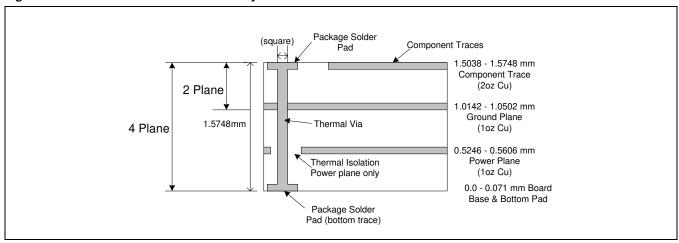


Figure 6.4 is a representation of how the heat can be conducted away from the die using an exposed pad package. Each application will have different requirements and limitations, and therefore the user should use sufficient copper to dissipate the power in the system. The output current rating of the linear regulators might need to be de-rated for higher ambient temperatures. The de-rated value will depend on the calculated worst-case power dissipation and the thermal management implementation in the application.



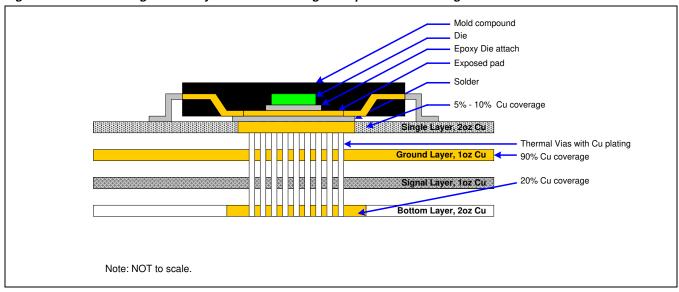


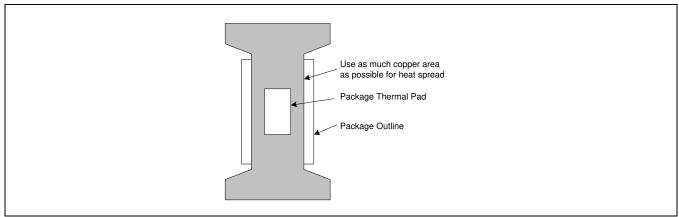
Figure 6.4 Conducting Heat Away from the Die using an Exposed Pad Package

6.3. Single-Layer PCB Layout

Layout recommendations for a single-layer PCB: Utilize as much copper area for power management as possible. In a single-layer board application, the thermal pad is attached to a heat spreader (copper areas) by using a low thermal impedance attachment method (solder paste or thermal conductive epoxy). In both of the methods mentioned above, it is advisable to use as much copper trace as possible to dissipate the heat.

Important: If the attachment method is NOT implemented correctly, the functionality of the product is NOT guaranteed. Power dissipation capability will be adversely affected if the device is incorrectly mounted onto the circuit board.







7 Ordering Information

Ordering Code*	Description	Package
ZSPM4121AI1 <i>W</i> 17	ZSPM4121 Under-Voltage Load Switch—V _{THRESH} factory set to 1.7V	8-pin DFN / 7" Reel (2500)
ZSPM4121AI1 <i>W</i> 21	ZSPM4121 Under-Voltage Load Switch—V _{THRESH} factory set to 2.1V	8-pin DFN / 7" Reel (2500)
ZSPM4121AI1 <i>W</i> 23	ZSPM4121 Under-Voltage Load Switch—V _{THRESH} factory set to 2.3V	8-pin DFN / 7" Reel (2500)
ZSPM4121AI1 <i>W</i> 24	ZSPM4121 Under-Voltage Load Switch—V _{THRESH} factory set to 2.4V	8-pin DFN / 7" Reel (2500)
ZSPM4121AI1 <i>W</i> 25	ZSPM4121 Under-Voltage Load Switch—V _{THRESH} factory set to 2.5V	8-pin DFN / 7" Reel (2500)
ZSPM4121AI1 <i>W</i> 26	ZSPM4121 Under-Voltage Load Switch—V _{THRESH} factory set to 2.6V	8-pin DFN / 7" Reel (2500)
ZSPM4121AI1 <i>W</i> 28	ZSPM4121 Under-Voltage Load Switch—V _{THRESH} factory set to 2.8V	8-pin DFN / 7" Reel (2500)
ZSPM4121AI1 <i>W</i> 30	ZSPM4121 Under-Voltage Load Switch—V _{THRESH} factory set to 3.0V	8-pin DFN / 7" Reel (2500)
ZSPM4121KIT	ZSPM4121 Evaluation Kit	

^{*} For a 13" reel (3300 parts), replace the W in the ordering code with an R. Custom V_{THRESH} values are also available: 1.2V to 4.2V (typical) in 100mV increments.

8 Related Documents

Document
ZSPM4121 Feature Sheet
ZSPM4121 Evaluation Kit Description
ZSPM4121 Application Note—Low Power Battery Control and Voltage Regulator Solutions for Remote Sensor Networks

Visit IDT's website www.IDT.com or contact your nearest sales office for the latest version of these documents.

15



9 Glossary

Term	Description
PG	Power Good (NPG = Power Good, active low)
RFID	Radio Frequency Identification
SPM	Smart Power Management

10 Document Revision History

Revision	Date	Description
1.00	April 30, 2012	First release
1.01	February 7, 2013	Addition of "Electrostatic Discharge – Charged Device Model" specification in section 1.1.
		Update for block diagram.
		Updates for V designation in marking codes in section 5.
		Edits for clarity.
		Update to IDT contact information.
	January 29, 2016	Changed to IDT branding.

IMPORTANT NOTICE AND DISCLAIMER

RENESAS ELECTRONICS CORPORATION AND ITS SUBSIDIARIES ("RENESAS") PROVIDES TECHNICAL SPECIFICATIONS AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS OR IMPLIED, INCLUDING, WITHOUT LIMITATION, ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for developers skilled in the art designing with Renesas products. You are solely responsible for (1) selecting the appropriate products for your application, (2) designing, validating, and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. Renesas grants you permission to use these resources only for development of an application that uses Renesas products. Other reproduction or use of these resources is strictly prohibited. No license is granted to any other Renesas intellectual property or to any third party intellectual property. Renesas disclaims responsibility for, and you will fully indemnify Renesas and its representatives against, any claims, damages, costs, losses, or liabilities arising out of your use of these resources. Renesas' products are provided only subject to Renesas' Terms and Conditions of Sale or other applicable terms agreed to in writing. No use o any Renesas resources expands or otherwise alters any applicable warranties or warranty disclaimers for these products.

(Disclaimer Rev.1.0 Mar 2020)

Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu, Koto-ku, Tokyo 135-0061, Japan www.renesas.com

Trademarks

Renesas and the Renesas logo are trademarks of Renesas Electronics Corporation. All trademarks and registered trademarks are the property of their respective owners.

Contact Information

For further information on a product, technology, the most up-to-date version of a document, or your nearest sales office, please visit:

www.renesas.com/contact/